

STRUCTURE Silicon monolithic integrated circuits

PRODUCT SERIES Bipolar stepping motor driver

TYPE BD6380EFV

FUNCTION - PWM constant current controllable two H bridge driver

· Power save mode

Reference voltage outputLow on resistance DMOS

○Absolute maximum ratings (Ta=25°C)

| Item | Symbol | Limit | Unit |
|--|---------------------------------------|-----------------------------|------------|
| Supply voltage VCC | V _{CC} | -0.2~+7.0 | V |
| Supply voltage VM | V _M | -0.2~+15.0 | < |
| Daniel diameter | D.1 | 1.1*1 | W |
| Power dissipation | Pd | 4.0 ^{*2} | W |
| Input voltage for control pin | V _{IN} | -0.2~(V _{CC} +0.3) | V |
| RNF maximum voltage | maximum voltage V _{RNF} | | V |
| Maximum output current | ximum output current I _{OUT} | | A/ch |
| Operating temperature range T _{opr} | | -25~+75 | င |
| Storage temperature range | T _{stg} | -55 ∼ +150 | $^{\circ}$ |
| Junction temperature T _{jmax} | | 150 | $^{\circ}$ |

^{*1 70}mm×70mm×1.6mm glass epoxy board. Derating in done at 8.8mW/°C for operating above Ta=25°C

Operating conditions (Ta=-25~+75°C)

| Item | Symbol | Min. | Тур. | Max. | Unit |
|---------------------------|-----------------|------|------|-----------------|------|
| Supply voltage VCC | V _{CC} | 2.5 | 3.3 | 5.5 | V |
| Supply voltage VM | V _M | 4.0 | 6.0 | 13.5 | V |
| Input voltage for control | V _{IN} | 0 | - | V _{CC} | ٧ |
| Output current (DC) | Іоит | - | 0.3 | 0.5*4 | A/ch |

^{*4} Do not exceed Pd, ASO.

This product isn't designed for protection against radioactive rays.

Status of this document

The Japanese version of this document is the formal specification.

A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document, formal version takes priority.

^{*2 4-}layer recommended board. Derating in done at 32.0mW/°C for operating above Ta=25°C.

^{*3} Do not exceed Pd, ASO.



○ Electrical characteristics (Unless otherwise specified Ta=25°C, VCC=3.3V, VM=6.0V)

| ltem | Cumbal | Limit | | | Unit | Conditions | |
|--|--------------------|-------|------|------|-------|------------------------------|--|
| item | Symbol | Min. | Тур. | Max. | Utill | Conditions | |
| Whole | | | | | | | |
| VCC current at standby | I _{CCST} | - | 0 | 10 | μΑ | PS=L | |
| VCC current | Icc | - | 1.6 | 3.0 | mA | PS=H, VLIMX=0.5V | |
| VM current at standby | I _{VMST} | • | 0 | 10 | μΑ | PS=L | |
| VM current | I _{VM} | - | 0.08 | 0.50 | mA | PS=H, VLIMX=0.5V | |
| Control input (PS, IN1A, IN1B, IN2A, IN2B) | | | | | | | |
| H level input voltage | V _{INH} | 2.0 | - | 3.3 | ٧ | | |
| L level input voltage | V _{INL} | 0 | - | 0.8 | ٧ | | |
| H level input current | I _{INH} | 15 | 30 | 60 | μΑ | V _{IN} =3V | |
| L level input current | I _{INL} | -10 | 0 | - | μΑ | V _{IN} =0V | |
| Output (OUT1A, OUT1B, OUT2A, OUT2B) | | | | | | | |
| Output ON resistance | Ron | _ | 1.2 | 1.5 | Ω | $I_{OUT} = \pm 0.3A$, VM=6V | |
| <u> </u> | | | | | | Sum of upper and lower | |
| Output leak current | ILEAK | - | - | 10 | μΑ | | |
| Current control | | | | | | | |
| RNFX input current | I _{RNF} | -40 | -20 | - | μΑ | RNFX=0V | |
| SENSEX input current | I _{SENSE} | -2.0 | -0.1 | - | μΑ | SENSEX=0V | |
| VLIMX input current | I _{VLIM} | -2.0 | -0.1 | - | μΑ | VLIMX=0V | |
| VLIMX input voltage range | V _{VLIM} | 0 | - | 0.5 | ٧ | | |
| Comparator offset voltage | V _{OFS} | -10 | - | 10 | mV | | |
| Noise cancel time | t _n | 0.3 | 0.7 | 1.2 | μs | R=39kΩ, C=1000pF | |
| VREF voltage | V _{VREF} | 0.97 | 1.00 | 1.03 | ٧ | I _{VREF} =0~1mA | |

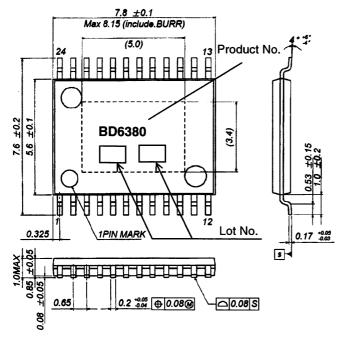
O Input-output logic table

| iput output logic table | | | | | | |
|-------------------------|-------|------|--------|-------|---------------------|--|
| | INPUT | | OUTPUT | | | |
| | IN1A | IN1B | OUT1A | OUT1B | | |
| PS | IN2A | IN2B | OUT2A | OUT2B | | |
| L | Х | Х | OPEN | OPEN | All circuit Standby | |
| Н | L | L | OPEN | OPEN | Standby | |
| Н | H | L | Н | L | Forward | |
| Н | L | Н | Ĺ | Н | Backward | |
| H | H | Н | L | L | Brake | |

X: H or L

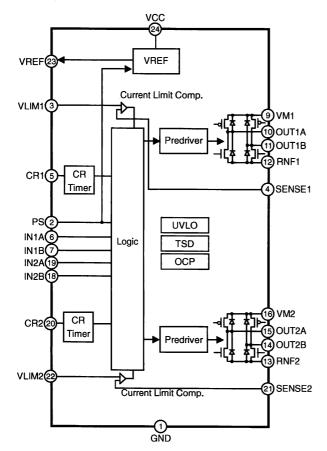


O Package outline



HTSSOP-B24 (Unit:mm)

OBlock diagram



○Pin No. / Pin name

| Pin No. | Pin name | Pin No. | Pin name |
|---------|----------|---------|----------|
| 1 | GND | 13 | RNF2 |
| 2 | PS | 14 | OUT2B |
| 3 | VLIM1 | 15 | OUT2A |
| 4 | SENSE1 | 16 | VM2 |
| 5 | CR1 | 17 | NC |
| 6 | IN1A | 18 | IN2B |
| 7 | IN1B | 19 | IN2A |
| 8 | NC | 20 | CR2 |
| 9 | VM1 | 21 | SENSE2 |
| 10 | OUT1A | 22 | VLIM2 |
| 11 | OUT1B | 23 | VREF |
| 12 | RNF1 | 24 | VCC |

NC: Non Connection



Operation Notes

(1) Absolute maximum ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down the devices, thus making impossible to identify breaking mode, such as a short circuit or an open circuit. If any over rated values will expect to exceed the absolute maximum ratings, consider adding circuit protection devices, such as fuses.

(2) Power supply lines

As return of current regenerated by back EMF of motor happens, take steps such as putting capacitor between power supply and GND as an electric pathway for the regenerated current. Be sure that there is no problem with each property such as emptied capacity at lower temperature regarding electrolytic capacitor to decide capacity value. If the connected power supply does not have sufficient current absorption capacity, regenerative current will cause the voltage on the power supply line to rise, which combined with the product and its peripheral circuitry may exceed the absolute maximum ratings. It is recommended to implement a physical safety measure such as the insertion of a voltage clamp diode between the power supply and GND pins.

(3) GND potential

The potential of GND pin must be minimum potential in all operating conditions.

(4) Thermal design

Use a thermal design that allows for a sufficient margin in light of the power dissipation (Pd) in actual operating conditions. This IC exposes its frame of the backside of package. Note that this part is assumed to use after providing heat dissipation treatment to improve heat dissipation efficiency. Try to occupy as wide as possible with heat dissipation pattern not only on the board surface but also the backside.

(5) Actions in strong electromagnetic field

Use caution when using the IC in the presence of a strong electromagnetic field as doing so may cause the IC to malfunction.

(6) ASO

When using the IC, set the output transistor so that it does not exceed absolute maximum ratings or ASO.

(7) Thermal shutdown circuit

The IC has a built-in thermal shutdown circuit (TSD circuit). If the chip temperature becomes Tjmax=150°C, and higher, coil output to the motor will be open. The TSD circuit is designed only to shut the IC off to prevent runaway thermal operation. It is not designed to protect or indemnify peripheral equipment. Do not use the TSD function to protect peripheral equipment.

(8) Ground Wiring Pattern

When using both small signal and large current GND patterns, it is recommended to isolate the two ground patterns, placing a single ground point at the ground potential of application so that the pattern wiring resistance and voltage variations caused by large currents do not cause variations in the small signal ground voltage. Be careful not to change the GND wiring pattern of any external components, either.

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